



ESD Diode

1. Features

• 2-pin lead-less package

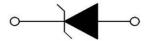
- Junction capacitance (Max value: 650pF)
- Peak Pulse current (8/20µs) Max:185A
- IEC61000-4-2 (ESD) ±30kV (air), ±30kV (contact)
- · Low clamping voltage
- · Low leakage current
- Working voltages:4.5V
- RoHS Compliant

2. Mechanical Data

- Case:Molded Plastic,DFN1610-2L.
- Epoxy:UL 94V-0 rate flame retardant.
- Terminals:Plated Leads Solderable per MIL-STD-750, Method-2026.
- Marking:H4T
- Marking:marked on body.

DFN1610-2L





Uni-directional

3. Maximum Ratings

Electrical Characteristics Rating at 25°C ambient temperature unless otherwise specified.

Characteristic	Symbol	Value	Unit	
Peak Pulse Power (tp=8/20µs waveform)	P _{PP}	2775	W	
Peak Pulse Current (8/20µs)	I _{PP}	185	Α	
ESD per IEC 61000-4-2 (Air)		±30	KV	
ESD per IEC 61000-4-2 (Contact)	V_{ESD}	±30	۲۸V	
Junction Temperature	T _j	-55~+125	$^{\circ}$	
Storage Temperature	T _{sta}	-55~+150	$^{\circ}\mathbb{C}$	

4. Electrical Characteristics (T_A=25℃ unless otherwise noted)

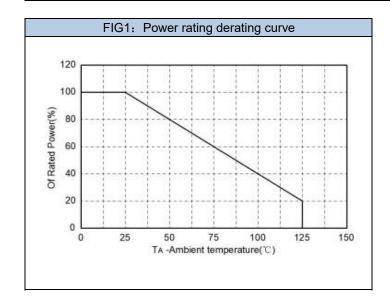
Characteristics	Symbol	Condition	Min	TYP	Max	Unit
Reverse Working Voltage	V_{RWM}		ı	1	4.5	V
Reverse Breakdown Voltage	V_{BR}	I _R = 1mA	4.8	1	7	V
Reverse Leakage Current	I _R	V _R =4.5V	•	-	0.2	uA
Clamping voltage	V _C	$I_{PP} = 10A, T_{P} = 8/20us$	-	-	7	V
Clamping voltage	V _C	$I_{PP} = 185A, T_{P} = 8/20us$	-	-	15	V
Junction capacitance	CJ	$V_R = 0V, f = 1MHz$	-	-	650	pF

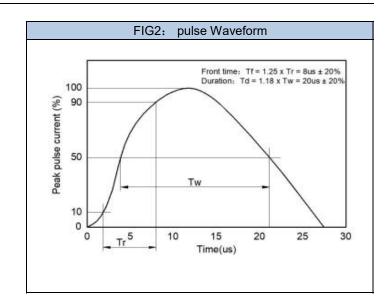


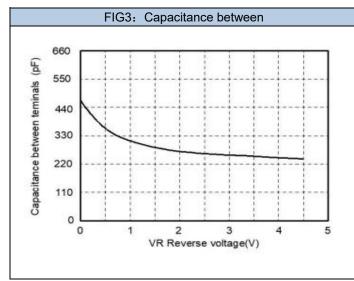


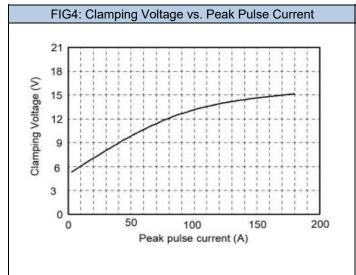


5. Rating And Characteristic Curves







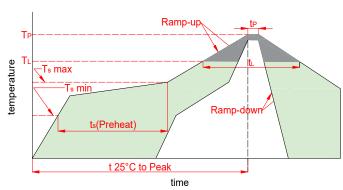






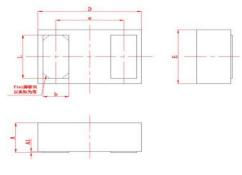
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6. Soldering Parameters

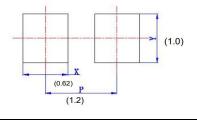


		Reflow Condition	Lead-free	
Γ		Temp. min(T _s (min))	150℃	
	Pre Heat	Temp. max(T _s (min))	200℃	
		Time(min to max)(t _s)	60~120s	
A	ver. ramp up rate(Liquidus Temp.)(T _L)to peak		3℃/s max	
լե	T _S (max) to T _L -Ramp-up Rate		3℃/s max	
ľ	Reflow	Temp.(T _L)(Liquidus)	217℃	
	Reliow	Temp.(t _L)(Liquidus)	60~150s	
F	Peak Temp.(T _P) Time within actual peak Temp.(t _p) Ramp-down Rate Time 25°C to peak Tempe.(T _p)		260 ^{+0/-5} ℃	
٦F			30s max	
F			6℃/s max	
٦			8 minutes max	
	Do not exce	eed	260℃	

7. Dimensions



Mounting PAD Layout



Symbol	Inc	hes	Millimeters		
Symbol	Min	Max	Min	Max	
Α	0.020	0.024	0.50	0.60	
A1	0.000	0.002	0.00	0.05	
D	0.022	0.067	0.55	1.70	
Е	0.035	0.043	0.90	1.10	
е	0.041		1.05		
b	0.014	0.018	0.35	0.45	
L	0.030	0.037	0.75	0.95	

8. Part Marking System

Cathode Band



9. Package Information

Package	Part Number	Marking Code	Quantity(pcs)
DFN1610-2L	ESDSHLC4V501P6	H4T	3000







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